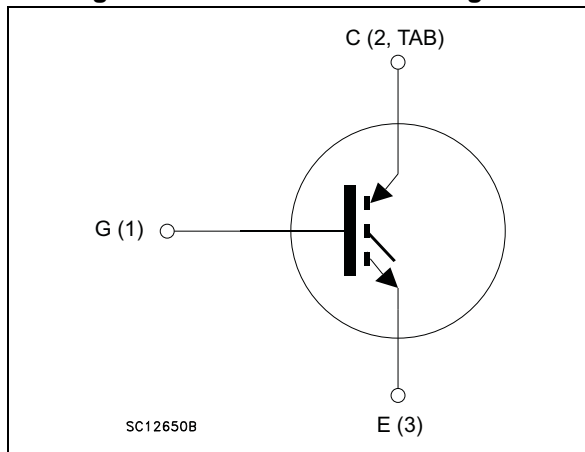


Figure 1. Internal schematic diagram



Features

- Maximum junction temperature: $T_J = 175\text{ °C}$
- High speed switching series
- Minimized tail current
- $V_{CE(sat)} = 1.6\text{ V (typ.) @ } I_C = 60\text{ A}$
- Tight parameters distribution
- Safe paralleling
- Low thermal resistance

Applications

- Photovoltaic inverters
- High frequency converters

Description

These are IGBT devices developed using an advanced proprietary trench gate and field-stop structure. The devices are part of the new HB series of IGBTs which represent an optimum compromise between conduction and switching loss to maximize the efficiency of any frequency converter. Furthermore, a slightly positive $V_{CE(sat)}$ temperature coefficient and very tight parameter distribution result in safer paralleling operation.

Table 1. Device summary

Order code	Marking	Package	Packing
STGW60H65FB	GW60H65FB	TO-247	Tube
STGWT60H65FB	GWT60H65FB	TO-3P	Tube

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1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{CES}	Collector-emitter voltage ($V_{GE} = 0$)	650	V
I_C	Continuous collector current at $T_C = 25\text{ °C}$	80 ⁽¹⁾	A
	Continuous collector current at $T_C = 100\text{ °C}$	60	
I_{CP} ⁽²⁾	Pulsed collector current	240	A
V_{GE}	Gate-emitter voltage	± 20	V
P_{TOT}	Total dissipation at $T_C = 25\text{ °C}$	375	W
T_{stg}	Storage temperature	-55 to 150	°C
T_j	Operating junction temperature	-55 to 175	

1. Current level is limited by bond wires.
2. Pulse width limited by maximum junction temperature.

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R_{thj-C}	Thermal resistance junction-case	0.4	°C/W
R_{thj-A}	Thermal resistance junction-ambient	50	

2 Electrical characteristics

$T_J = 25\text{ °C}$ unless otherwise specified.

Table 4. Static characteristics

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{(BR)CES}$	Collector-emitter breakdown voltage ($V_{GE} = 0$)	$I_C = 2\text{ mA}$	650			V
$V_{CE(sat)}$	Collector-emitter saturation voltage	$V_{GE} = 15\text{ V}, I_C = 60\text{ A}$		1.60	2.0	V
		$V_{GE} = 15\text{ V}, I_C = 60\text{ A}$ $T_J = 125\text{ °C}$		1.75		
		$V_{GE} = 15\text{ V}, I_C = 60\text{ A}$ $T_J = 175\text{ °C}$		1.85		
$V_{GE(th)}$	Gate threshold voltage	$V_{CE} = V_{GE}, I_C = 1\text{ mA}$	5	6	7	V
I_{CES}	Collector cut-off current ($V_{GE} = 0$)	$V_{CE} = 650\text{ V}$			25	μA
I_{GES}	Gate-emitter leakage current ($V_{CE} = 0$)	$V_{GE} = \pm 20\text{ V}$			± 250	nA

Table 5. Dynamic characteristics

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
C_{ies}	Input capacitance	$V_{CE} = 25\text{ V}, f = 1\text{ MHz},$ $V_{GE} = 0$	-	7792	-	pF
C_{oes}	Output capacitance		-	262	-	
C_{res}	Reverse transfer capacitance		-	158	-	
Q_g	Total gate charge	$V_{CC} = 520\text{ V}, I_C = 60\text{ A},$ $V_{GE} = 15\text{ V},$ see Figure 23	-	306	-	nC
Q_{ge}	Gate-emitter charge		-	126	-	
Q_{gc}	Gate-collector charge		-	58	-	

Table 6. Switching characteristics (inductive load)

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit	
$t_{d(on)}$	Turn-on delay time	$V_{CE} = 400\text{ V}$, $I_C = 60\text{ A}$, $R_G = 10\ \Omega$, $V_{GE} = 15\text{ V}$, see Figure 22	-	66		ns	
t_r	Current rise time		-	38	-	ns	
$(di/dt)_{on}$	Turn-on current slope		-	1216		A/ μ s	
$t_{d(off)}$	Turn-off delay time				210		ns
t_f	Current fall time		-	20	-	ns	
$E_{on}^{(1)}$	Turn-on switching loss		-	1590	-	μ J	
$E_{off}^{(2)}$	Turn-off switching loss		-	900	-	μ J	
E_{ts}	Total switching loss	-	2490	-	μ J		
$t_{d(on)}$	Turn-on delay time	$V_{CE} = 400\text{ V}$, $I_C = 60\text{ A}$, $R_G = 10\ \Omega$, $V_{GE} = 15\text{ V}$, $T_J = 175\text{ }^\circ\text{C}$, see Figure 22	-	59		ns	
t_r	Current rise time		-	40	-	ns	
$(di/dt)_{on}$	Turn-on current slope		-	1230		A/ μ s	
$t_{d(off)}$	Turn-off delay time				242		ns
t_f	Current fall time		-	147	-	ns	
$E_{on}^{(1)}$	Turn-on switching loss		-	2860	-	μ J	
$E_{off}^{(2)}$	Turn-off switching loss		-	1255	-	μ J	
E_{ts}	Total switching loss	-	4115	-	μ J		

1. Energy loss includes reverse recovery of the external diode. The diode is the same as the co-packaged STGW60H65DFB.
2. Turn-off loss also includes the tail of the collector current.

2.1 Electrical characteristics (curve)

Figure 2. Output characteristics ($T_J = 25^\circ\text{C}$)

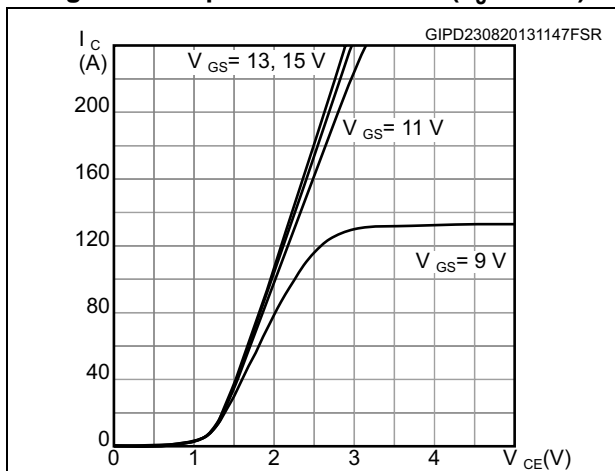


Figure 3. Output characteristics ($T_J = 175^\circ\text{C}$)

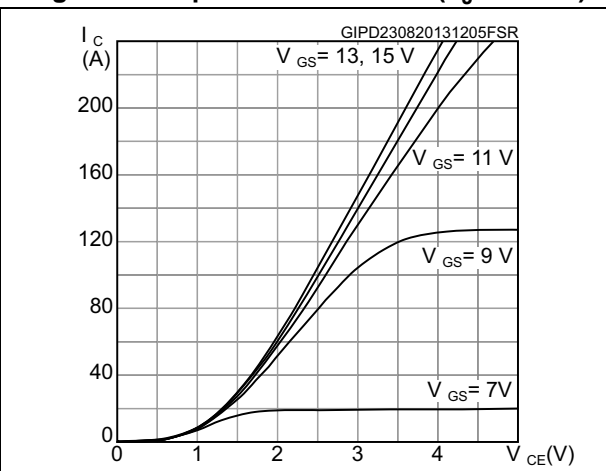


Figure 4. Transfer characteristics

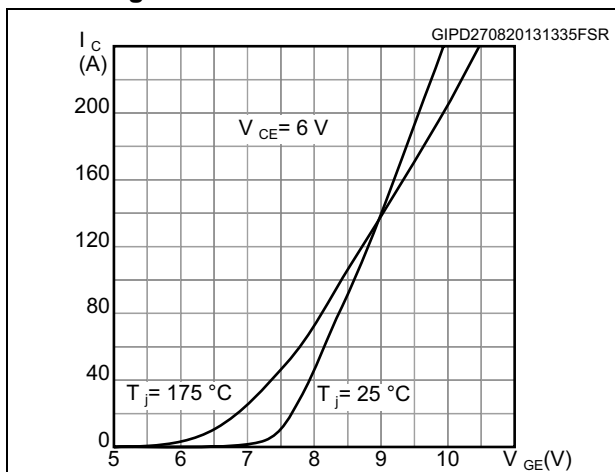


Figure 5. Collector current vs. case temperature

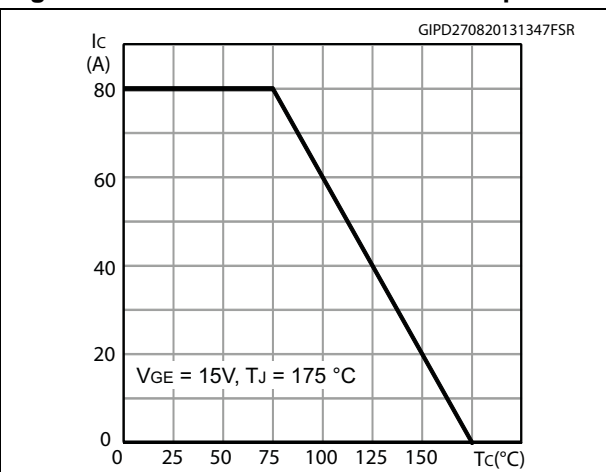


Figure 6. Power dissipation vs. case temperature

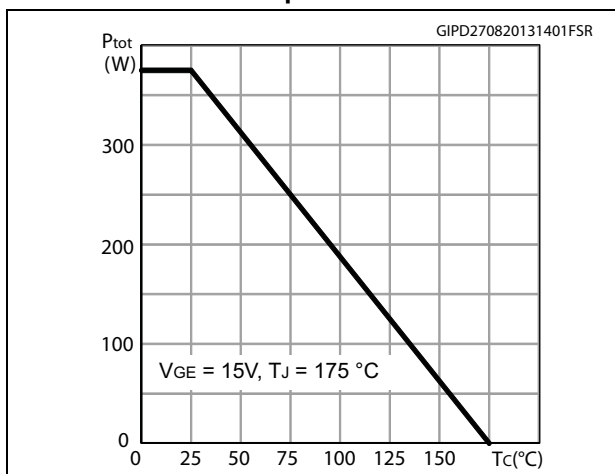


Figure 7. $V_{CE(sat)}$ vs. junction temperature

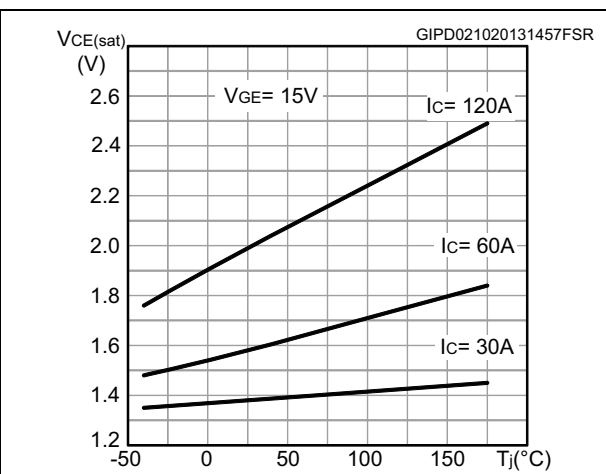


Figure 8. $V_{CE(sat)}$ vs. collector current

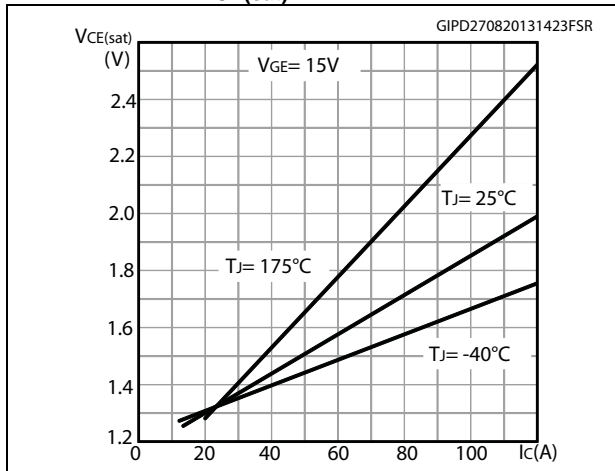


Figure 9. Forward bias safe operating area

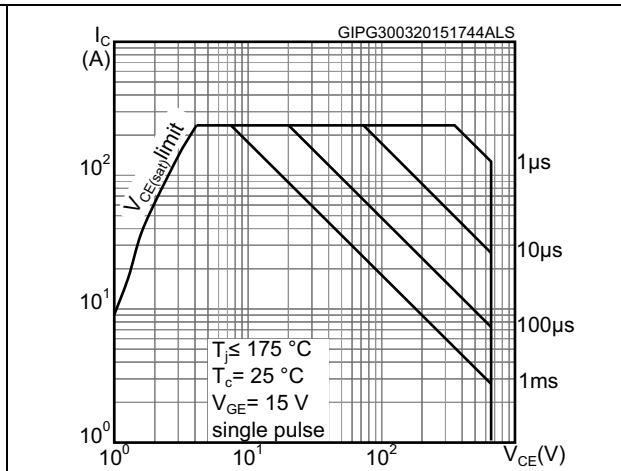


Figure 10. Normalized $V_{(BR)CES}$ vs. junction temperature

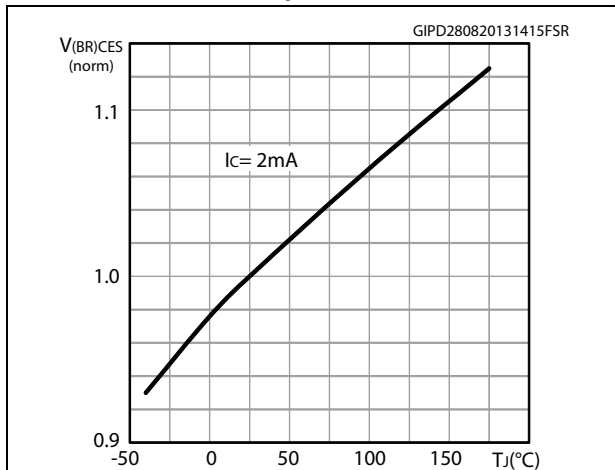


Figure 11. Normalized $V_{GE(th)}$ vs. junction temperature

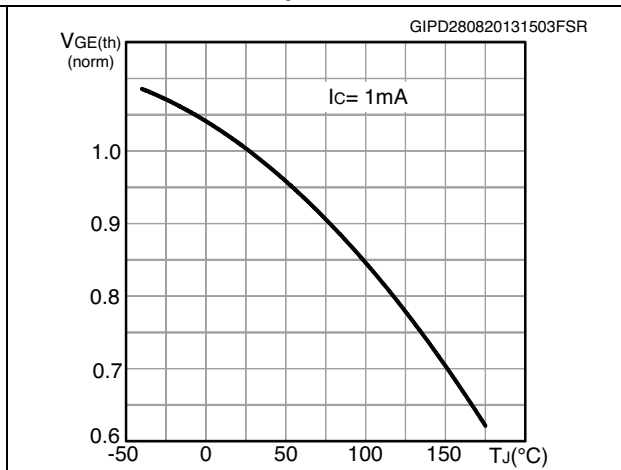


Figure 12. Gate charge vs. gate-emitter voltage

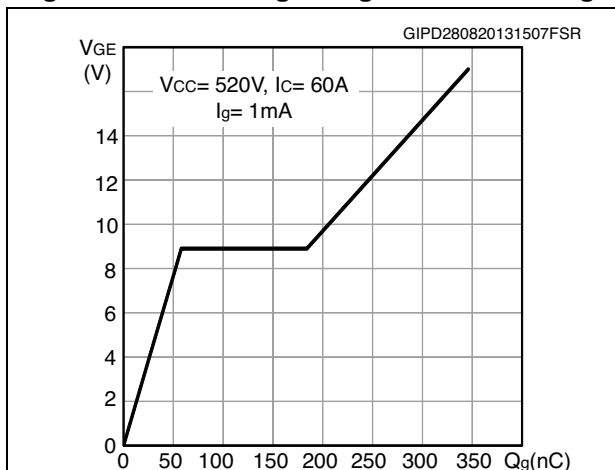


Figure 13. Switching loss vs temperature

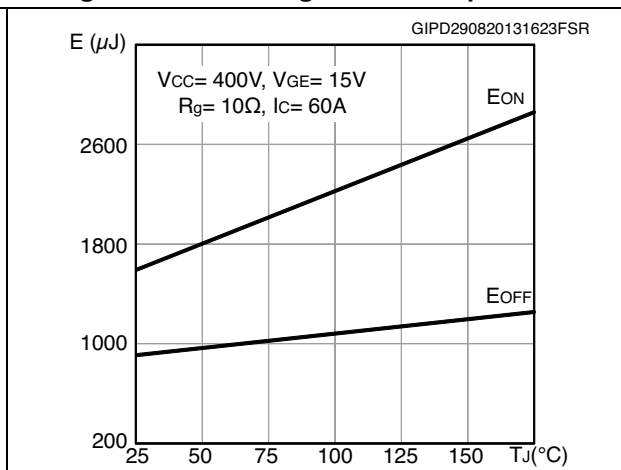


Figure 14. Switching loss vs gate resistance

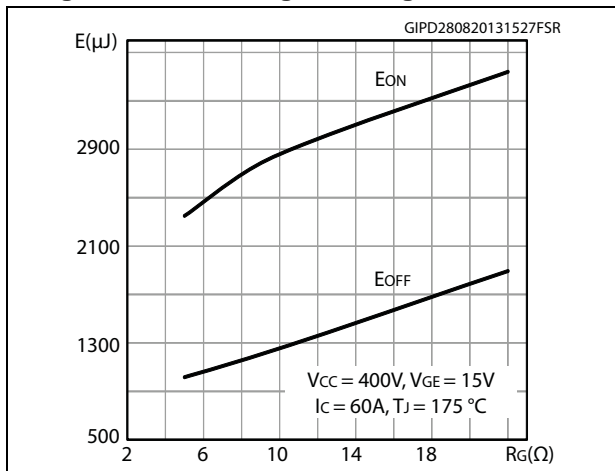


Figure 15. Switching loss vs collector current

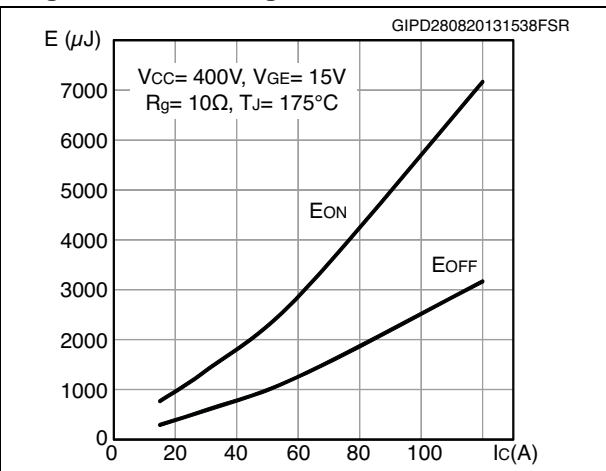


Figure 16. Switching loss vs collector emitter voltage

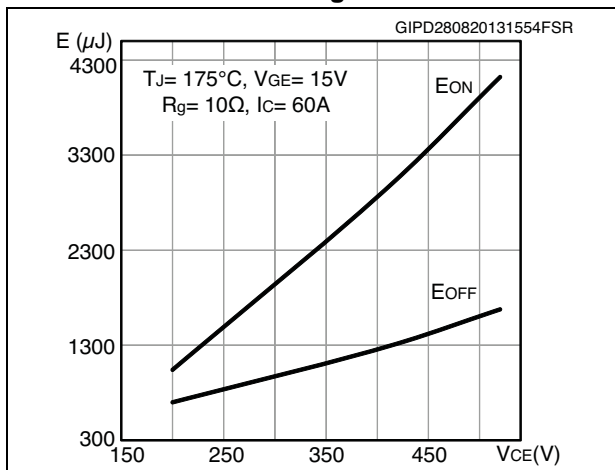


Figure 17. Switching times vs collector current

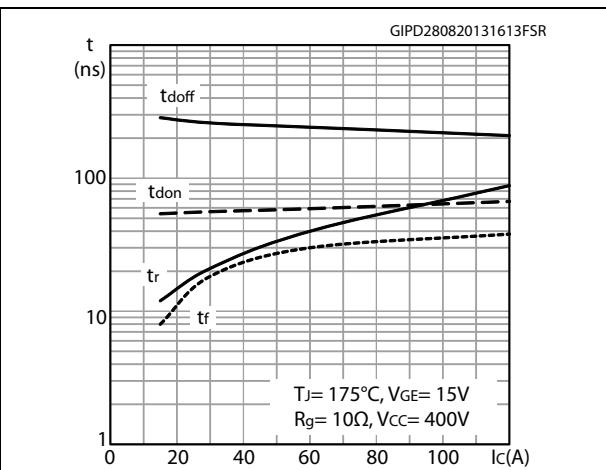


Figure 18. Switching times vs gate resistance

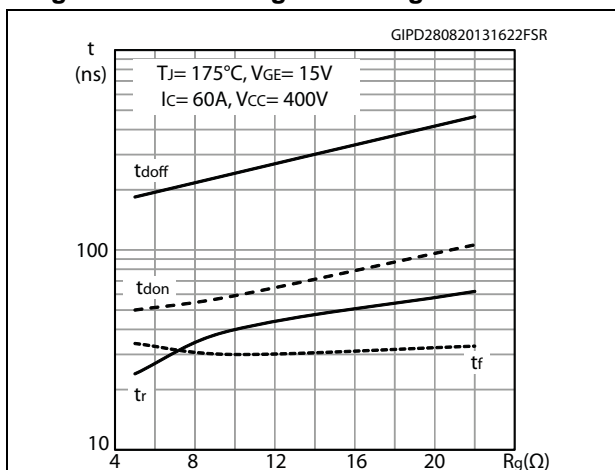


Figure 19. Capacitance variations

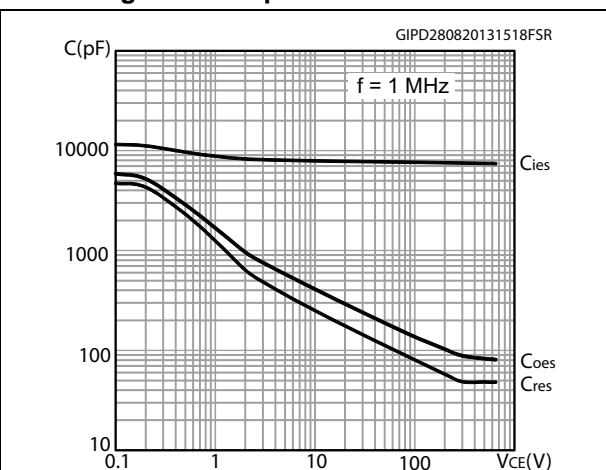


Figure 20. Collector current vs. switching frequency

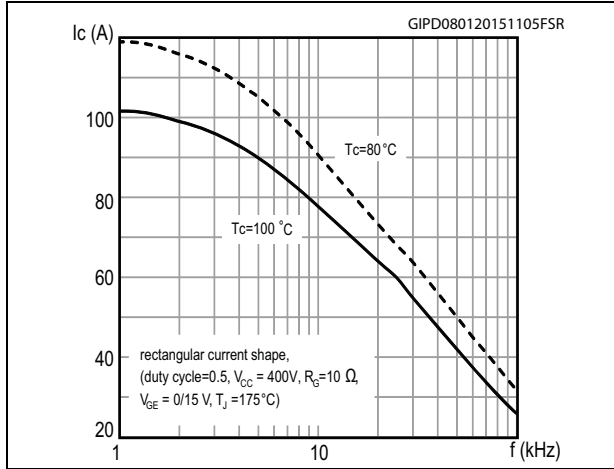
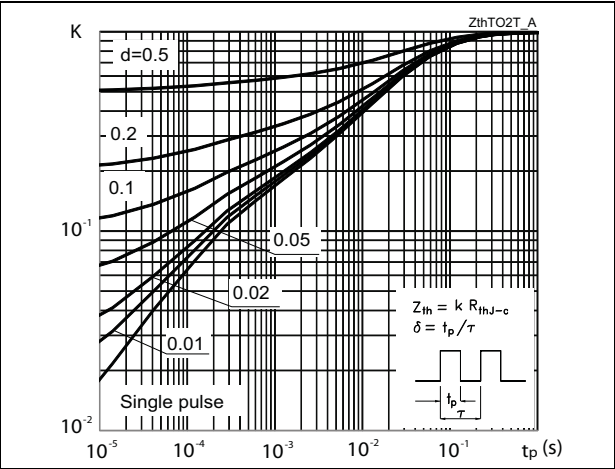


Figure 21. Thermal impedance



3 Test circuits

Figure 22. Test circuit for inductive load switching

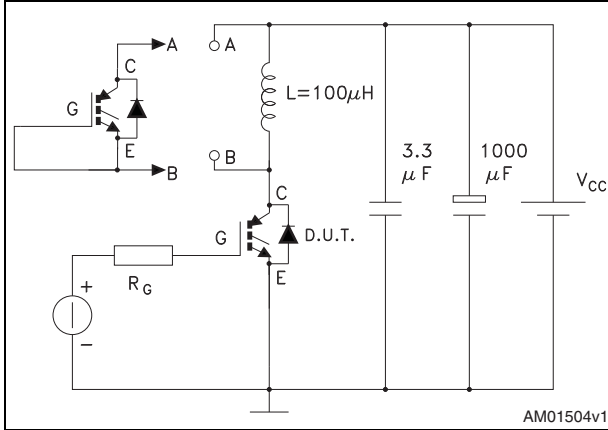


Figure 23. Gate charge test circuit

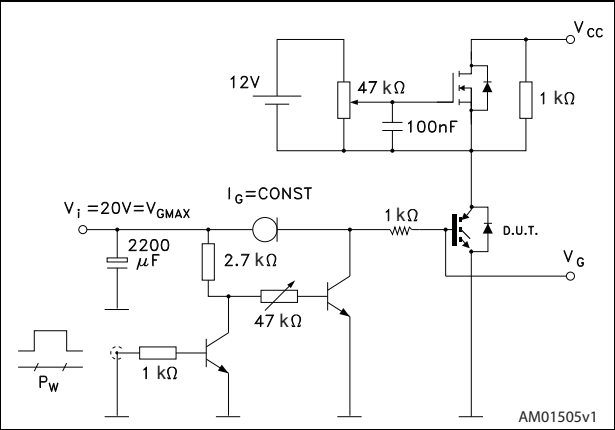
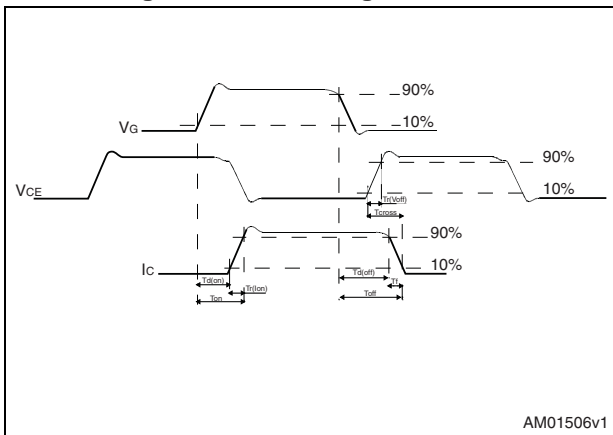


Figure 24. Switching waveform



4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

4.1 TO-247 package information

Figure 25. TO-247 package outline

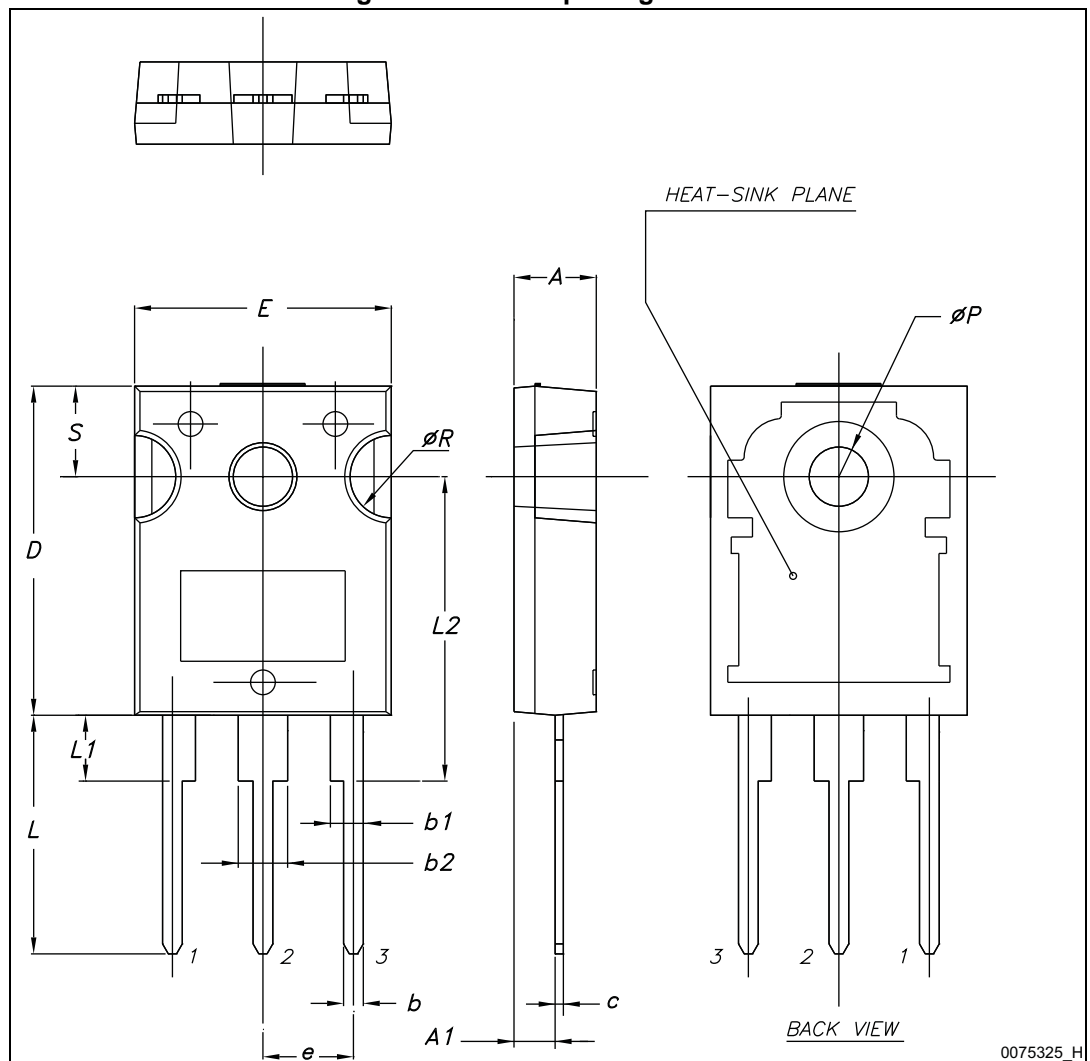


Table 7. TO-247 mechanical data

Dim.	mm.		
	Min.	Typ.	Max.
A	4.85		5.15
A1	2.20		2.60
b	1.0		1.40
b1	2.0		2.40
b2	3.0		3.40
c	0.40		0.80
D	19.85		20.15
E	15.45		15.75
e	5.30	5.45	5.60
L	14.20		14.80
L1	3.70		4.30
L2		18.50	
ØP	3.55		3.65
ØR	4.50		5.50
S	5.30	5.50	5.70

Table 8. TO-3P mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A	4.60	4.80	5
A1	1.45	1.50	1.65
A2	1.20	1.40	1.60
b	0.80	1.00	1.20
b1	1.80	2.00	2.20
b2	2.80	3.00	3.20
c	0.55	0.60	0.75
D	19.70	19.90	20.10
D1	13.70	13.90	14.10
E	15.40	15.60	15.80
E1	13.40	13.60	13.80
E2	9.40	9.60	9.90
e	5.15	5.45	5.75
L	19.80	20	20.20
L1	3.30	3.50	3.70
L2	18.20	18.40	18.60
øP	3.30	3.40	3.50
øP1	3.10	3.20	3.30
Q	4.80	5	5.20
Q1	3.60	3.80	4

5 Revision history

Table 9. Document revision history

Date	Revision	Changes
30-Aug-2013	1	Initial release.
28-Feb-2014	2	Updated title and features in cover page.
09-Jan-2015	3	Updated features in cover page, Table 2: Absolute maximum ratings , Table 4: Static characteristics and Table 6: Switching characteristics (inductive load) . Updated Figure 5: Collector current vs. case temperature , Figure 6: Power dissipation vs. case temperature , Figure 8: $V_{CE(sat)}$ vs. collector current , Figure 17: Switching times vs collector current , Figure 18: Switching times vs gate resistance and Figure 19: Capacitance variations . Added Figure 20: Collector current vs. switching frequency . Updated Section 4: Package information . Minor text changes.
01-Apr-2015	4	Text edits throughout document Updated Table 2: Absolute maximum ratings Updated Table 4: Static characteristics Updated Table 6: Switching characteristics (inductive load) Updated Section 2.1: Electrical characteristics (curve) .

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